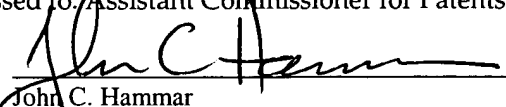


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PATENT APPLICATION

I certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first-class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231.
2-20-02

John C. Hammar

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: M. Kistner *et al.*
Appl. No.: 09/967,269
Filing Date: September 28, 2002

Examiner:
Art Unit:
Docket: 97-064B
February 20, 2002

For: *Combined Superplastic Forming and Adhesive Bonding*

Assistant Commissioner for Patents
Washington, DC 20231



INFORMATION APPLICANT CITES THAT MAY BE MATERIAL
TO THE PROSECUTION OF THE SUBJECT APPLICATION

Sir:

Applicant files this INFORMATION DISCLOSURE STATEMENT prior to the first action. No fee is due. In the event that Applicant should owe a fee, however, please charge that fee to Deposit Account 02-2960. Should Applicant owe a fee (including any fees under §1.17 or all required extension of time fees), please charge that fee to Deposit Account 02-2960. Please treat this paper (and any future reply) as incorporating a petition for extension of time for the appropriate length of time, in the event that an extension is required.